Fast Statistical Analysis of Rare Circuit Failure Events in High-Dimensional Variation Space Student: Shupeng Sun; Advisor: Xin Li **Carnegie Mellon** ECE Department, Carnegie Mellon University, Pittsburgh, PA, USA **Subset Simulation (SUS): Continuous Performance Metric** Motivation **Idea**: find K subsets $\{\Omega_k; k = 1, 2, \dots, K\}$ in **x**-space, and estimate the rare failure rate P_F by the conditional probabilities $\{P_k; k = 1, 2, \dots, K\}$ cell $\Omega_1 \supseteq \Omega_2 \supseteq \cdots \supseteq \Omega_{K-1} \supseteq \Omega_K = \Omega$ **x** : process variation cell Ω : interested failure region $P_F = \Pr(\mathbf{x} \in \Omega) = \Pr(\mathbf{x} \in \Omega_1) \prod \Pr(\mathbf{x} \in \Omega_k | \mathbf{x} \in \Omega_{k-1}) = \prod P_k$ \bullet \bullet \bullet P_F : interested failure rate cell cell Example SA $P_1 = \Pr(\mathbf{x} \in \Omega_1) = 0.1$ -SAi7 Processor $P_2 = \Pr(\mathbf{x} \in \Omega_2 | \mathbf{x} \in \Omega_1) = 0.1$ **Applying SUS** σ_f : σ of f(x)**Simplified SRAM Architecture** $P_F = \Pr(\mathbf{x} \in \Omega)$ $P_3 = \Pr(\mathbf{x} \in \Omega_3 | \mathbf{x} \in \Omega_2) = 0.1$ **Challenge:** all the components need to function correctly under large process variations ✓ **Proposed SSS** $=10^{-4}$ $P_4 = \Pr(\mathbf{x} \in \Omega_4 | \mathbf{x} \in \Omega_3) = 0.1$ Fabricated Fabricated Designed Estimate P_1, P_2, P_3, P_4 Estimate P_F **Question**: how to estimate these conditional probabilities $\{P_k; k = 1, 2, \dots, K\}$? **Process Variation Phase 1**: draw random samples from PDF $f(\mathbf{x})$ and estimate $P_1 = \Pr(\mathbf{x} \in \Omega_1)$ $s_1 \quad s_2 \quad s_3$ **Yield requirement**: each component must be extremely robust under process variations ✓ Experimental results x_1, x_2 are generally modeled as independent Normal random variables **Time to market:** fast statistical tools are highly desired to analyze the rare failure event CLK N_{Y} : # of yellow points N_G : # of green points **Existing Approaches** $N_G + N_Y$ **Phase 2**: draw random samples from $f(\mathbf{x} \mid \mathbf{x} \in \Omega_1)$ and estimate $P_2 = \Pr(\mathbf{x} \in \Omega_2 \mid \mathbf{x} \in \Omega_1)$ $f(\mathbf{x} \mid \mathbf{x} \in \Omega_1)$ is **unknown** in advance. **Modified Metropolis** (MM) algorithm is applied • 45nm CMOS technology to generate random samples that follow $f(\mathbf{x} \mid \mathbf{x} \in \Omega_1)$ $f_1(x_1)$ MM • Cons: difficult to find an appropriate biased sampling distribution in **high-D** space $\uparrow q_1(x_1-x_1^a)$ $(x_1^*)'$ $\mathbf{x}^a = \left(x_1^a, x_2^a \right)$ else r_1 is drawn from Uniform(0,1) **Deterministic approach** [4]: integrate the failure region in the variation space $f(\mathbf{x}) = f_1(x_1) \cdot f_2(x_2)$ **-8**-60 40 $f_2(x_2)'$ (a) MNIS $\mathbf{\uparrow} q_2 \left(x_2 - x_2^a \right)$ • Cons: expensive to accurately describe the failure region in **high-D** space **Challenge: High-Dimensionality** $x_{2}^{*} \quad r_{2} \leq \min \left| 1, f_{2}(x_{2}^{*}) / f_{2}(x_{2}^{a}) \right|$ ✓ In the past, rare failure event analysis was mainly focused on SRAM bit cell \leftarrow low-D 60 else (b) SUS Recently, rare failure event analysis in high-D becomes more and more important r_2 is drawn from Uniform(0,1) $\mathbf{x}^* \notin \boldsymbol{\Omega}_1 \quad \mathbf{x}^* = \left(x_1^b, x_2^b \right)$ $\mathbf{x}^b = \langle$ 1. Dynamic SRAM bit cell stability related to peripherals: many transistors from multiple $\mathbf{X} \quad \mathbf{X} \in \Omega_1$ the "golden" failure rate. SRAM bit cells and their peripheral circuits must be considered Ω_1 N_G : # of green points N_R : # of red points MM CLK CLK← CELL<0> $P_2^{SUS} = \frac{N_R}{N_R}$ CELL<63> CLK $N_G + N_R$ BLsamples created in Phase 1 SA *JOUT* **Phase 3**: similar to Phase 2 $\bullet \quad \bullet \quad \bullet$



